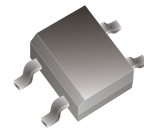


B05S-G Thru B10S-G

Reverse Voltage: 50 to 1000 Volts

Forward Current: 0.8 A

RoHS Device

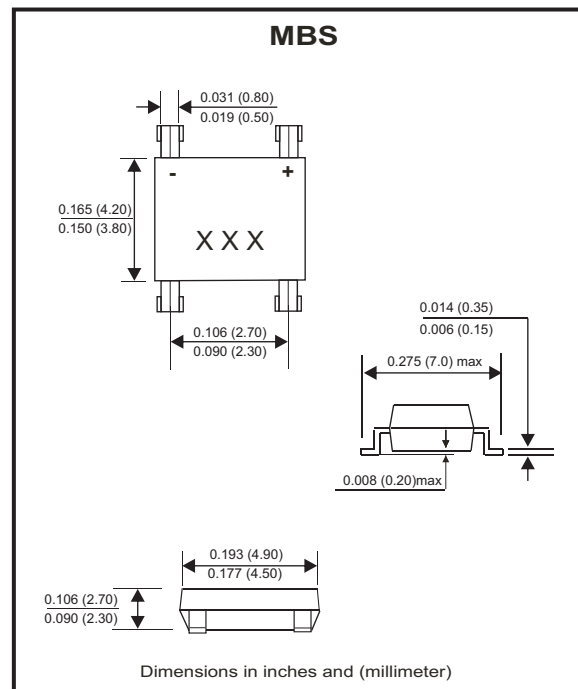


Features

- Rating to 1000V PRV.
- Ideal for printed circuit board.
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product.
- Pb free product.

Mechanical data

- Polarity: Symbol molded on body.
- Weight: 0.125 grams.
- Mounting position: Any.



Maximum Rating And Electrical Characteristics

Rating at $T_A=25^{\circ}\text{C}$, unless otherwise noted.
 Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Parameter	Symbol	B05S-G	B1S-G	B2S-G	B4S-G	B6S-G	B8S-G	B10S-G	Unit
	Marking	B05S	B1S	B2S	B4S	B6S	B8S	B10S	
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (Note 1) @ $T_A=40^{\circ}\text{C}$	$I_{(AV)}$	0.8							A
Peak Forward Surge Current, 8.3ms single half sine-wave, superimposed on rated load (JEDEC Method)	I_{FSM}	30							A
Maximum Forward Voltage at 0.8A DC	V_F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage @ $T_J=25^{\circ}\text{C}$ @ $T_J=125^{\circ}\text{C}$	I_R	5.0 500							μA
Typical Junction Capacitance per element (Note 2)	C_J	15							pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$	75							$^{\circ}\text{C/W}$
Operating Temperature Range	T_J	-55 to +150							$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150							$^{\circ}\text{C}$

Notes: 1. Mounted on P.C. Board.
 2. Measured at 1MHz and applied reverse voltage of 4V DC.
 3. Thermal resistance: Junction to Ambient.

RATING AND CHARACTERISTIC CURVES (B05S-G thru B10S-G)

Fig.1 - Forward Current Derating Curve

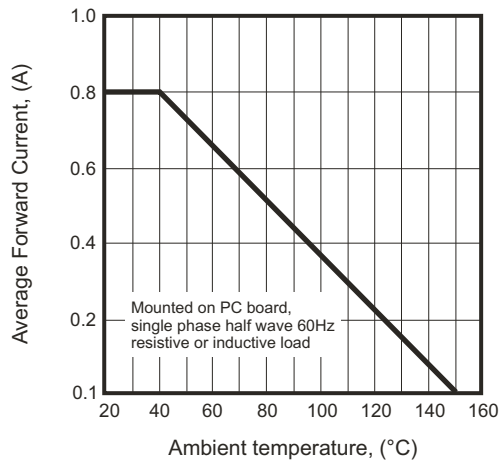


Fig.2 - Maximum Non-Repetitive Surge Current

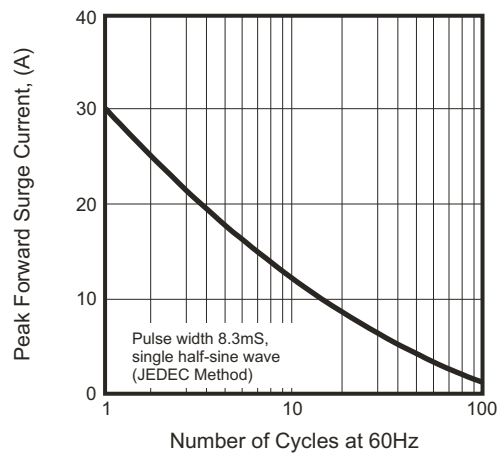


Fig.3 - Typical Reverse Characteristics

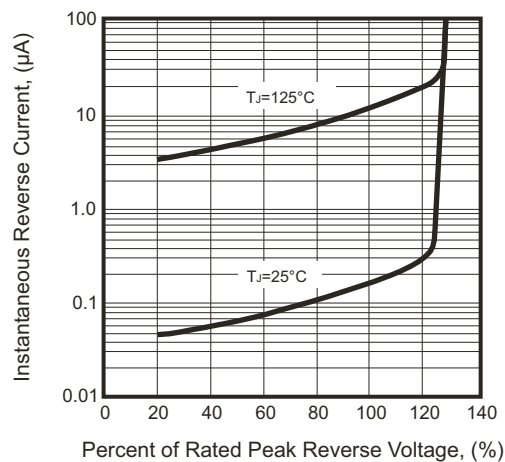


Fig.4 - Typical Forward Characteristics

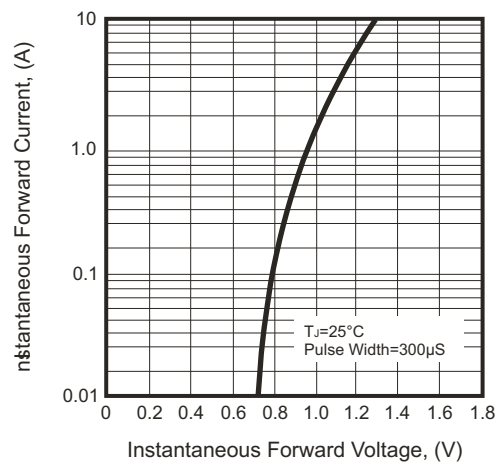
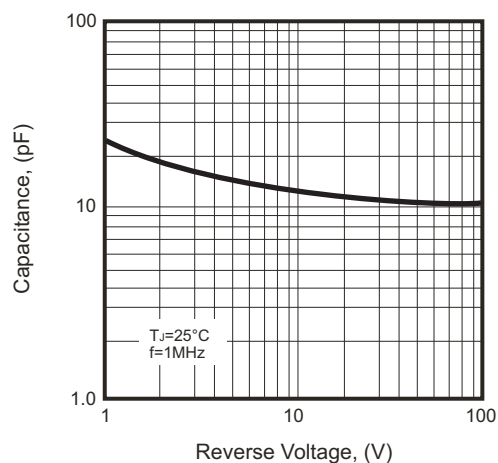
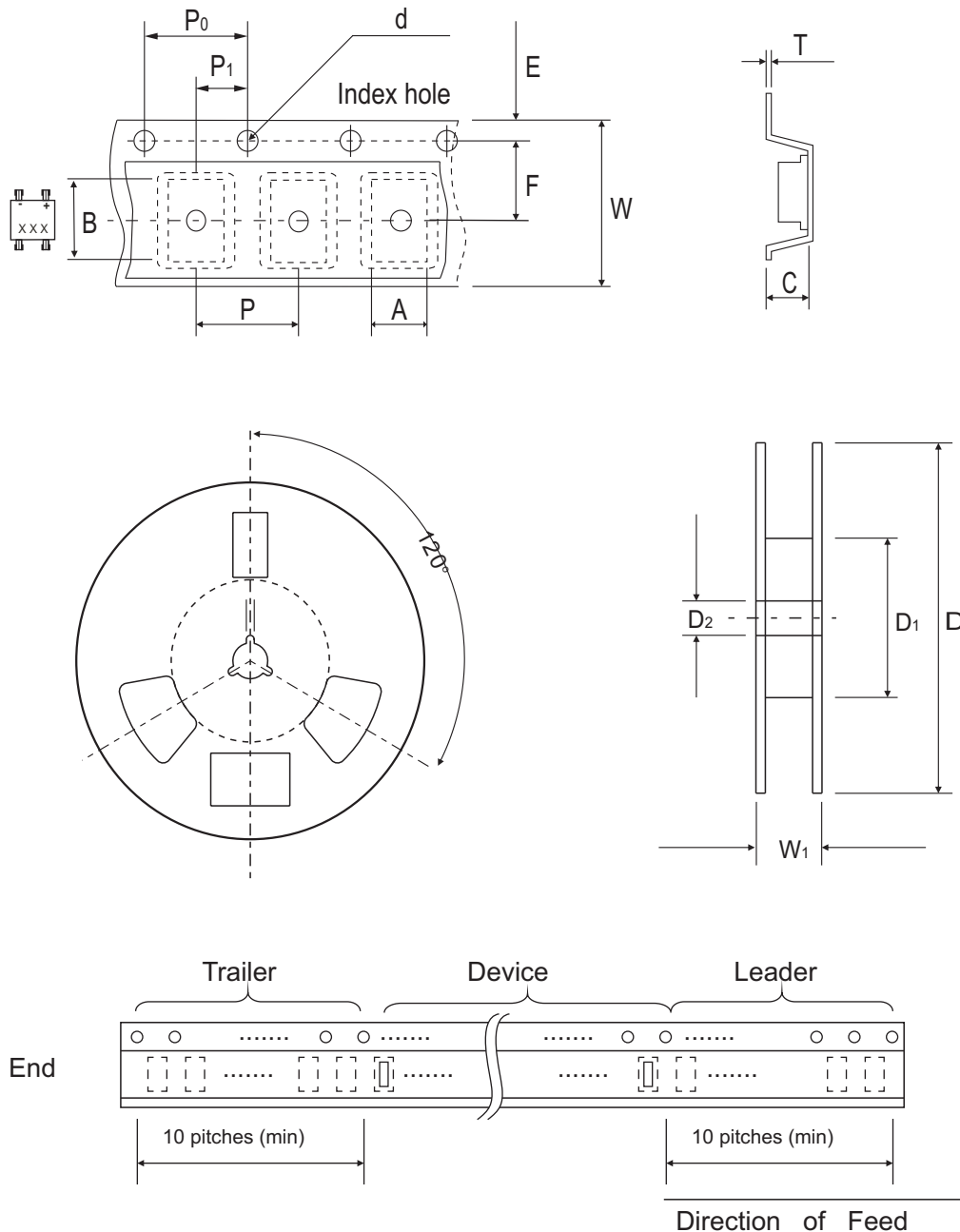


Fig.5 - Typical Junction Capacitance



Reel Taping Specification

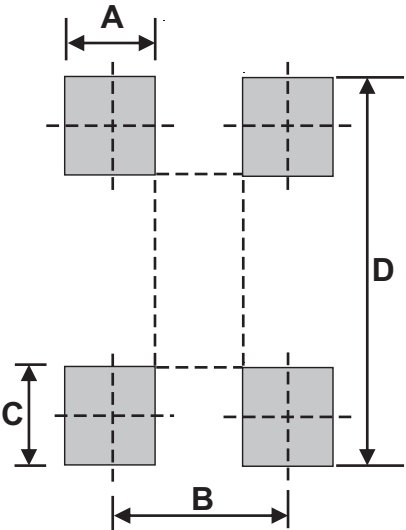


MBS	SYMBOL	A	B	C	d	D	D ₁	D ₂
	(mm)	4.90 ± 0.10	7.24 ± 0.10	3.33 ± 0.10	1.55 ± 0.05	330	50.0 MIN.	13.00 ± 0.20
	(inch)	0.193 ± 0.004	0.285 ± 0.004	0.131 ± 0.004	0.061 ± 0.002	13	1.969 MIN.	0.512 ± 0.008

MBS	SYMBOL	E	F	P	P ₀	P ₁	T	W	W ₁
	(mm)	1.75 ± 0.10	5.50 ± 0.05	8.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	0.30	12.00 ± 0.30	12.00~14.40
	(inch)	0.069 ± 0.004	0.217 ± 0.002	0.315 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.012	0.472 ± 0.012	0.472~0.657

Suggested PAD Layout

SIZE	MBS	
	(mm)	(inch)
A	0.82MIN	0.032MIN
B	2.55REF	0.100REF
C	0.92MIN	0.036MIN
D	7.00MAX	0.276MAX



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
MBS	3,000	13

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